4.2 × 3.2mm Compact High Operating Force (Surface Mount Type)

High operation force satisfies the needs in automotive applications. Wide stem & good mountability







■ Typical Specifications

Items	Specifications
Rating (max.)	50mA 16V DC
Rating (min.)	10 µA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.2

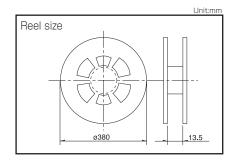
■ Product Line

Product No.	Operating force	Operating direction	Operating life	Stem color	Minimum order unit (pcs.)		
T TOUGGE TWO.	Operating force	Operating direction	(5mA 5V DC)	Otern color	Japan	Export	
SKRPABE010	1.57N		100,000 cycles	Natural Black	4,000	4,000	
SKRPACE010	2.55N	Top puch	50,000 cycles				
SKRPADE010	4N	Top push	100,000 avalos				
SKRPARE010	5N		100,000 cycles	DIdUK			

■ Packing Specifications

Taping

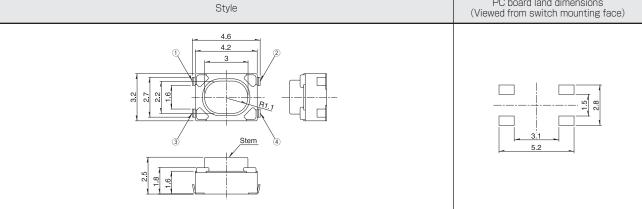
Num	ber of packages (Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
4,000	40,000	40,000	12	395×395×205



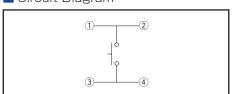
Note

For reels of 330mm diameter, please inquire.

Dimensions Style PC board land dimensions (Visual fram switch mounting fool)



Circuit Diagram



Refer to P.265 for soldering conditions.

	Type				Sh	arp Feeling T	уре			
1,750			T		(Surface Mour	nt			I
	Series	SKRK	SKTH	SKRP	SKQM	SKQY	SKSU	SKST	SKRA	SKHM
	Photo	-	S. Sand						0	1
	Features	Compact size Low-profile	Compact size	High operation force Compact size	Compa	act size		Middle trave	el	_
	Water-proof	_	_	_	_	_	•	_	0	_
	Dust-proof	_	•	_	_	_	•	_	0	_
	IP standard	_	_	_	_	_	67 equivalency	_	67 equivalency	_
Operatir	Top push	•	•	•	•	•	•	•	•	•
directio		_	_	_	_	_	_	_	_	_
	W	3.9	3.5	4.2	6	6.1	5.3			6.2
Dimensio (mm)		2.9	3.2	3.2	3.5	3.7	5.4	8.5	□6.2	6.5
(11111)	Н	1.5/2	1.8/2.5	2.5	4.3/5	2.5	3.85	3.95	3.5/5.2	3.1
Operation force coverage	2N to 3N	1	1		Î		‡	+	1	1
	Travel (mm)	0.13	0.12	0.2	0.	25	0.7	0.9	See the relevant pages for respective product descriptions	0.25
G	round terminal	_	_	_	_	0	_	_	_	•
Operating temperature range		-40℃ to +85℃			_	40℃ to +90)°C		1	-40℃ to +85℃
А	utomotive use	_	•	•	•	•	•	•	0	_
	Life Cycle	* 2	* 2	*3	* 2	* 2	*3	* 2	*3	3
	Rating (max.) (Resistive load)	50mA 12V DC	25mA 16V DC	50mA 16V DC	50mA	12V DC	50mA 1	6V DC	50mA	12V DC
Electrical	Rating (min.) (Resistive load)	10μA 1V DC								
performance	Insulation resistance	100MΩ min. 100V DC 1min.								
	Voltage proof	250V AC 1min.								
Dahilit.	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively								
Durability	Lifetime	Shall be in accordance with individual specifications.								
	Cold	-40°	C 96h	-40°C 1,000h -40°C 96h -40°C 1,0			-40°C 1,00C	C 1,000h -		
Environmental performance	Dry heat	90°C	96h	90°C 1,000h 90°C 96h		90°C 1,000h			90℃ 96h	
	Damp heat	60°C, 90 to	95%RH 96h	60°C, 90 to 95%RH 96h 60°C, 90 to 959) to 95%RF	%RH 1,000h 60°C 95%l		
	Page	230	232	234	235	236	238	239	240	241

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

TACT Switch™ Soldering Conditions · · · · · · · · · · · · · · · · · · ·	
TACT Switch™ Cautions · · · · · · · · · · · · · · · · · · ·	36

Notes

 $[\]hbox{1. The automotive operating temperature range to be individually discussed upon request.}\\$

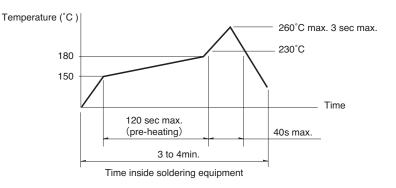
^{2.} Indicates applicability to all products in the series, while O indicates applicability to some products in the series.

TACT Switch™ Soldering Conditions

■ Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface).
 - A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others.
 The above-stated conditions shall also apply to switch surface temperatures.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

Manual Soldering

Items		Condition
	Soldering temperature	350℃ max.
	Duration of soldering	3s max.
	Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)

单击下面可查看定价,库存,交付和生命周期等信息

>>ALPS Electric(阿尔卑斯)